# EXPERIMENTAL STUDY ON THERMAL CONTACT CONDUCTANCE OF BEAD BLASTED SS 304 AT LIGHT LOADS

Fernando H. Milanez<sup>\*</sup>, J. Richard Culham<sup>†</sup>, M. Michael Yovanovich<sup>‡</sup>

Microelectronics Heat Transfer Laboratory - Department of Mechanical Engineering University of Waterloo, Waterloo, ON, Canada, N2L 3G1

# **NOMENCLATURE**

$c_1$	Vickers microhardness correlation coeff. [Pa]
<i>C</i> <sub>2</sub>	Vickers microhardness correlation coeff. [ ]
E	Young's modulus [Pa]
$h_c$	contact conductance [W/m <sup>2</sup> K]
Н	microhardness [Pa]
$k_s$	= $2k_Ak_B/(k_A+k_B)$ , harmonic mean thermal conductivity [W/mK]
т	combined mean absolute slope [radians] = $\sqrt{m_A^2 + m_B^2}$
Р	contact pressure [Pa]
q	heat flux [W/m <sup>2</sup> ]
SS	stainless steel
Т	temperature [K]

Research Assistant, milanez@mhtlab.uwaterloo.ca

<sup>†</sup> Associate Professor, Director MHTL, rix@mhtlab.uwaterloo.ca,

‡Distinguished Professor Emeritus, Fellow AIAA, mmyov@mhtlab.uwaterloo.ca

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## Greek Symbols:

$\Delta T$	temperature drop [K]
V	Poisson's ratio
σ	combined RMS roughness [m], = $\sqrt{\sigma_A^2 + \sigma_B^2}$
Subscripts:	
A,B	contacting bodies

c contact

*v* Vickers micro-hardness

# **INTRODUCTION**

Contact heat transfer has many applications in engineering, such as ball bearings, spacecraft thermal control, microelectronic chips and nuclear fuel heat dissipation. Several models to predict thermal contact resistance/conductance are available in the literature. Sridhar and Yovanovich<sup>1</sup> presented an extensive survey of the most accepted thermal contact conductance models available. They compared the models against SS 304, Ni 200, Al 6061, Zr-Nb and Zr-4 data collected by other researchers and concluded that the Cooper et al.<sup>2</sup> plastic model and the Mikic<sup>3</sup> elastic model are accurate to predict the experimental data, especially for high contact pressures. At light contact pressures, the theoretical models tend to underpredict experiments. The main objective of this work is to verify the deviation between experiments and theory at light loads.

In order to compare experiments and elastic or plastic models, it is convenient to know what is the deformation mode experienced by the contacting asperities. Mikic<sup>3</sup> proposed an index to predict if the deformation is either elastic or plastic. According to the author, the deformation mode depends on the geometry of the asperities and the mechanical properties of the contacting solids and does not depend on the magnitude of the contact pressure. In this work, the deformation mode of the contacting asperities is tested experimentally by measuring the contact conductance both in ascending and descending levels of contact pressures. It is well known that when the deformation is plastic, the thermal contact conductance measured in descending levels of contact pressure is always larger than in ascending levels because of the hysteresis effect (Mikic<sup>4</sup>, McWaid<sup>5</sup>, Li et al.<sup>6</sup>, among others). The plastic deformation generated during the first loading is not recovered during the unloading, therefore the contact spots are larger than during the first loading.

# **REVIEW OF THERMAL CONTACT CONDUCTANCE MODELS**

The Cooper et al.<sup>2</sup> plastic model and the Mikic<sup>3</sup> elastic model are used here. These models were developed for isotropic surfaces (such as bead blasted). Yovanovich<sup>7</sup>, presented the following simple correlation for the Cooper et al.<sup>2</sup> plastic model:

$$\frac{h_c \sigma}{k_s m} = 1.25 \left(\frac{P}{H_c}\right)^{0.95} \tag{1}$$

where  $P/H_c$ , the dimensionless contact pressure, is computed using the model proposed by Song and Yovanovich<sup>8</sup>:

$$\frac{P}{H_c} = \left[\frac{P}{c_1 (1.62\sigma/m)^{c_2}}\right]^{\frac{1}{1+0.071c_2}}$$
(2)

Mikic<sup>3</sup>, presented the following correlation for his elastic model:

$$\frac{h_c \sigma}{k_s m} = 1.55 \left(\frac{\sqrt{2}P}{mE'}\right)^{0.94} \tag{3}$$

where:

$$E' = \left(\frac{1 - \upsilon_A^2}{E_A} + \frac{1 - \upsilon_B^2}{E_B}\right)^{-1}$$
(4)

is the effective Young's modulus of the contacting bodies (A and B).

#### EXPERIMENTAL STUDY

The experimental study consists of measuring the thermal contact conductance between two SS 304 specimens under vacuum environment. The two specimens are nominally flat, with one of the contacting specimens smooth (lapped) and the other rough (bead blasted). The experimental set-up and procedure used here is basically the same as employed by other researchers (McWaid<sup>5</sup>, Li et al.<sup>6</sup>, among others). It consists basically of a cold plate, testing column (two contacting samples), load cell, electrical heater and loading mechanism. Heat is dissipated in the electrical heater, crosses the test column and is absorbed by the cold plate. The contact pressure is read by means of a load cell.

The temperature distribution of the testing column is measured by means of six #36 type T thermocouples positioned 5 mm apart from each other along the longitudinal direction in each sample. A computational code uses the least square method to find the best linear fit for the temperature distribution inside each test specimen. The heat fluxes of each sample are obtained by multiplying the slope of the temperature distributions by the conductivity of the SS 304, which is a function of the temperature and is given by the following expression:

$$k_{SS304} = 17.7 + 0.028 T \qquad 4 < T < 90^{\circ} C \tag{5}$$

This correlation was obtained in a previous conductivity test using calibrated ARMCO fluxmeters.

All four SS 304 specimens were machined from the same bar stock to cylinders of 25 mm diameter by 45 mm long. The specimens were then ground flat, lapped by means of a mechanical lapping machine and further hand-lapped in order to obtain maximum flatness. The flatness deviations of the lapped surfaces were checked using a monochromatic light source and an optical flat and did not exceed 0.5  $\mu$ m. Two specimens remained flat and the other two specimens were

bead blasted to two different roughness levels (0.72 and 1.31  $\mu$ m). The roughnesses were measured with a stylus profilometer both before and after the tests and the differences were negligible. A Vickers micro-hardness test was performed on one of the flat specimens and the Vickers micro-hardness correlation coefficients obtained using this procedure were  $c_1$ =10.6 GPa and  $c_2$ =-0.40.

The test procedure consisted of assembling the testing pair (one flat lapped and one bead blasted sample) inside the vacuum chamber. The chamber was closed and vacuum was drawn using a mechanical pump connected in series with a diffusion punp. The vacuum inside the chamber was 10<sup>-6</sup> torr. The electrical heater was turned "on" and the system was left for at least 16 hours to achieve steady state. The thermal contact conductance was computed by means of the following expression:

$$h_c = \frac{q}{\Delta T} \tag{6}$$

where q [W/m<sup>2</sup>] is the average of the heat fluxes of the two contacting specimens. The temperature drop  $\Delta T$  [K], is computed by extrapolating the temperature profiles of each contacting specimen to the interface. For comparison between the experiment and theory, the thermal conductivity of SS 304 ( $k_s$  appearing in Eqs. 1 and 3) is evaluated at the mean temperature of the contact, which is the average of the two extrapolated temperatures.

This procedure was repeated for each contact pressure level tested. The pressure levels varied from 15.8 kPa, to approximatelly 3000 kPa in both ascending and descending levels. Two loading/unloading cycles were measured for each pair. The system was considered to be in steady state when the thermal contact conductance between the specimens did not vary more than 1% in 1 hour. As the contact pressure was increased between each pressure step, the power level of the electrical heater was increased in order to maintain a reasonable temperature drop (8 to 40°C) between the samples. The mean temperature of the interface ranged from 15 to 60°C.

For light contact pressures, the uncertainty of heat flux measurement is  $\pm 5$  % and the uncertainty of the temperature drop across the interface is  $\pm 1$  %. Using the methodology of error propagation (Holman<sup>9</sup>), the uncertainty of the thermal contact conductance measurements is  $\pm 5$ % for the lightest contact pressure. For the highest contact pressure, the uncertainties of the heat flux and of the temperature drop were both  $\pm 2$  %, and the thermal contact conductance uncertainty is also  $\pm 5$  %.

## EXPERIMENTAL RESULTS AND COMPARISON WITH THEORY

Figure 1(a) shows the results for the smoothest of the two pairs tested ( $\sigma$  = 0.72 µm). It can be clearly seen that the hysteresis loop appears during both the first and second loading/unloading cycles. The maximum difference between loading and unloading is 100% for the first cycle and 75% for the second cycle. Therefore, during both first and second loading/unloading cycles the asperities undergo plastic deformation. The comparison between the experimental results and the plastic model (Eq. 1) for the first loading is reasonably good, specially for large contact pressures. At the lightest contact pressure, the plastic model underpredicts the first loading data by approximatelly 40%. The elastic model (Eq. 3) predicts larger values of thermal contact conductance than the plastic model and is in fairly good agreement with the first unloading and the second loading/unloading cycle for high contact pressures despite the asperities had already been plastically deformed during first loading.

The results for the roughest test pair ( $\sigma = 1.31 \ \mu m$ ) and the comparison against both the elastic and the plastic models are shown in Fig. 1(b). The hysteresis loop is evident during the first loading/unloading cycle but not during the second cycle. The second loading/unloading cycle data points lie approximately over the same curve as the first unloading. These observations lead to the conclusion that the deformation is plastic during the first loading and elastic during the subsequent unloading/loading/unloading cycles. The plastic model predicts the first loading data very well for high contact pressures, similar to the smoother pair. For light contact pressures, the plastic model underpredicts the experimental data by a maximum difference of 70% for the lightest contact pressure. The elastic and the plastic models predict similar values of contact conductance for this pair, and the elastic model predicts the first loading very well, specially at high contact pressures. However, the appearance of the hysteresis loop clearly shows that the deformation is plastic during first loading. If one simply compares first loading data with the elastic model, the good agreement could suggest that the deformation of the asperities is elastic, which is not true. On the other hand, by measuring a complete loading/unloading cycle it is easy to verify that the deformation mode of the contacting asperities is plastic in this case. The data points for first unloading and second loading/unloading cycle lie well above the models, as expected, due to the plastic deformation experienced by the asperities during first loading.

The plastic model presents the same behavior when compared with both test pairs: for the first loading it underpredicts the experimental data at light loads, but as the pressure increases the theoretical prediction gets closer to the measured values. This observation is in agreement with the experimental data compiled by Sridhar and Yovanovich<sup>1</sup>. Since this phenomenon has been consistently detected by different researchers employing different set-ups, it does not seem to be a weakness of the experimental program adopted here. The present authors believe that this is a weakness of the theoretical models. The theoretical models assume a Gaussian asperity height distribution, but the authors believe that the highest asperities of real surfaces are truncated. At light contact pressures, only the higher asperities come into contact and the truncation of the highest asperities makes the mean separation between the contacting surfaces smaller than predicted by the Gaussian model. As the actual separation is smaller than predicted, the actual thermal contact conductance is higher than predicted by the Gaussian model, especially at light

contact pressures. As the contact pressure increases, more and more asperities come into contact and the effect of the few truncated asperities becomes negligible. A new thermal contact conductance model that takes the effect of the truncation of the contacting asperities into account is needed.

## CONCLUSIONS

The appearance of the hysteresis loop indicated that the contact between bead blasted/lapped SS 304 is plastic during the first loading/unloading cycle for both roughness levels tested (0.72 and  $1.31 \,\mu m$ ). The plastic model of Cooper et al.<sup>2</sup> predicted first loading data points very well for high contact pressures. For light contact pressures, the model underpredicts the experiments. Other researchers employing different experimental set-ups have systematically noticed this unexpected behavior, indicating that this is a weakness of the theoretical models. The present authors believe that the models underpredict the experiments at light loads due to the truncation of the highest asperities; the highest asperities are shorter than predicted by the models. A new model is needed for the light contact pressure range.

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## **REFERENCES**

<sup>1</sup>Sridhar, M. R. and Yovanovich, M. M., "Review of Elastic and Plastic Contact Conductance Models: Comparison with Experiment," *Journal of Thermophysics and Heat Transfer*, Vol. 8, No. 4, 1994, pp. 633-640.

<sup>2</sup>Cooper, M., Mikic, B. and Yovanovich, M. M., "Thermal Contact Conductance," *Journal of Heat and Mass Transfer*, Vol.12, 1969, pp. 279-300.

<sup>3</sup>Mikic, B. B., "Thermal Contact Conductance; Theoretical Considerations," *Journal of Heat and Mass Transfer*, Vol. 17, 1974, pp. 205-214.

<sup>4</sup>Mikic, B. B., "Analytical Studies of Contact of Nominally Flat Surfaces; Effect of Previous Loading," *Journal of Lubrication Technology*, Vol. 20, 1971, pp. 451-456.

<sup>5</sup>McWaid, T. H. "Thermal Contact Resistance Across Pressed Metal Contact in a Vacuum Environment," Ph. D. Dissertation, University of California, Santa Barbara, CA, 1990.

<sup>6</sup>Li, Y. Z., Madhusudana, C. V. and Leonardi, E., "On the Enhancement of the Thermal Contact Conductance: Effect of Loading History," *Journal of Heat Transfer*, Vol. 122, 2000, pp. 46-49.

<sup>7</sup>Yovanovich, M. M., "Thermal Contact Correlations," *Spacecraft Radiative Heat Transfer and Temperature Control*, Edited by T. E. Horton, Progress in Astronautics and Aeronautics, Vol. 83, NY, 1981, pp.83-95.

<sup>8</sup>Song, S. and Yovanovich, M. M., "Relative Contact Pressure: Dependence on Surface Roughness and Vickers Microhardness," *Journal of Thermophysics and Heat Transfer*, Vol.2, No. 4, pp. 633-640, 1988.

<sup>9</sup>Holman, J. P., *Experimental Methods for Engineers*, 6<sup>th</sup> Edition, McGraw-Hill, Singapore, pp. 49-51, 1994.



(a)



Figure 1 – SS 304 bead blasted/lapped contact conductance results